LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER :		
MODULE NO.:	WO256128	A-TFH#
APPROVED BY:		
(FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.		SUMMARY	
Е	2019/12/17		1	Precautions CD Modules	in



DOC. FIRST ISSUE RECORDS OF REVISION **REVISED** VERSION **SUMMARY** DATE PAGE NO. 2015/12/21 First issue 0 2016/01/05 Add External Power Supply Circuit. 2016/01/27 Modify Precautions in use B of LCD Modules & Static electricity test Add FPC bending rule \mathbf{C} 2016/11/21 Modify Material List of 2019/08/27 Components for RoHs Modify Precautions in use 2019/12/17 E of LCD Modules

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1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 256 * 128 dot

Model serials no.

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow EL$, Yellow Green $G\rightarrow LED$, Green $H\rightarrow DIP$ LED, Amber $F\rightarrow CCFL$, White $P\rightarrow LED$, Blue $I\rightarrow DIP$ LED, Red

 $Y\rightarrow$ LED, Yellow Green $X\rightarrow$ LED, Dual color $G\rightarrow$ LED, Green $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

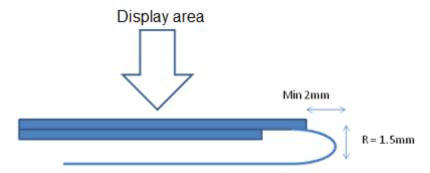
Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code #:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11) The limitation of FPC bending



(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit				
Number of dots	256 x 128	_				
Module dimension	80.0 x 54.0 x 9.5	mm				
View area	70.7 x 38.8	mm				
Active area	66.54 x 33.26	mm				
Dot size	0.24 x0.24	mm				
Dot pitch	0.26 x 0.26	mm				
LCD type	FSTN Positive Transflective (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)					
Drive Method	1/128 DUTY,1/12 BIAS					
View direction	6 o'clock					
Backlight Type	LED, White					
IC	ST75256	ST75256				

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
MPU Interface Input Voltage	Vin	-0.3	_	V _{DD} +0.3	V
Digital Power Supply Voltage	V _{DD} -Vss	-0.3	_	4.0	V
LCD Power supply voltage	V0- XV0	-0.3	_	19.0	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{ m DD} ext{-}V_{ m SS}$	_	3.0	3.3	3.6	V
		Ta=-20°C	_	_	_	V
Supply Voltage For LCM	V_{OP}	Ta=25°C	14.2	14.5	14.8	V
		Ta=70°C	_	_	_	V
Input High Volt.	V_{IH}	_	$0.7~\mathrm{V_{DD}}$	_	$V_{ m DD}$	V
Input Low Volt.	V _{IL}	_	V _{SS}	_	0.3 V _{DD}	V
Output High Volt.	V _{OH}	_	$0.8~\mathrm{V_{DD}}$	_	V_{DD}	V
Output Low Volt.	V_{OL}	_	V_{SS}	_	0.2 V _{DD}	V
Supply Current	I_{DD}	V _{DD} =3.3V	_	1.5	_	mA

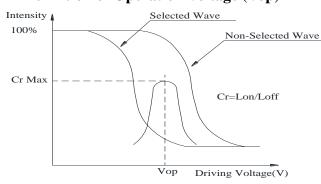
Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

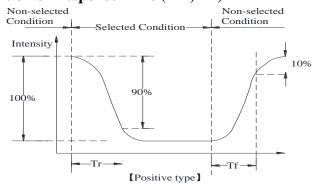
6.Optical Characteristics

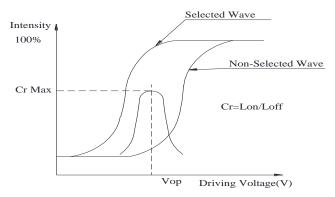
Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
Response Time	T rise	_	_	200	300	ms
	T fall	_	_	250	350	ms

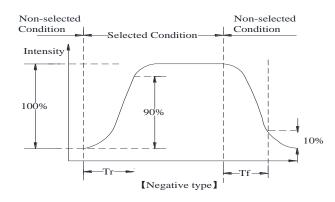
Definition of Operation Voltage (Vop)

Definition of Response Time (Tr , Tf)









Conditions:

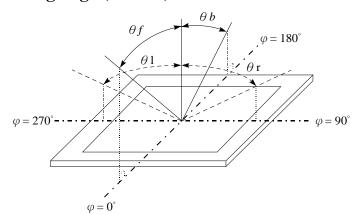
Operating Voltage : Vop

Viewing Angle(θ , φ): 0° , 0°

Frame Frequency: 64 HZ Driving Wav

Driving Waveform: 1/N duty, 1/a bias

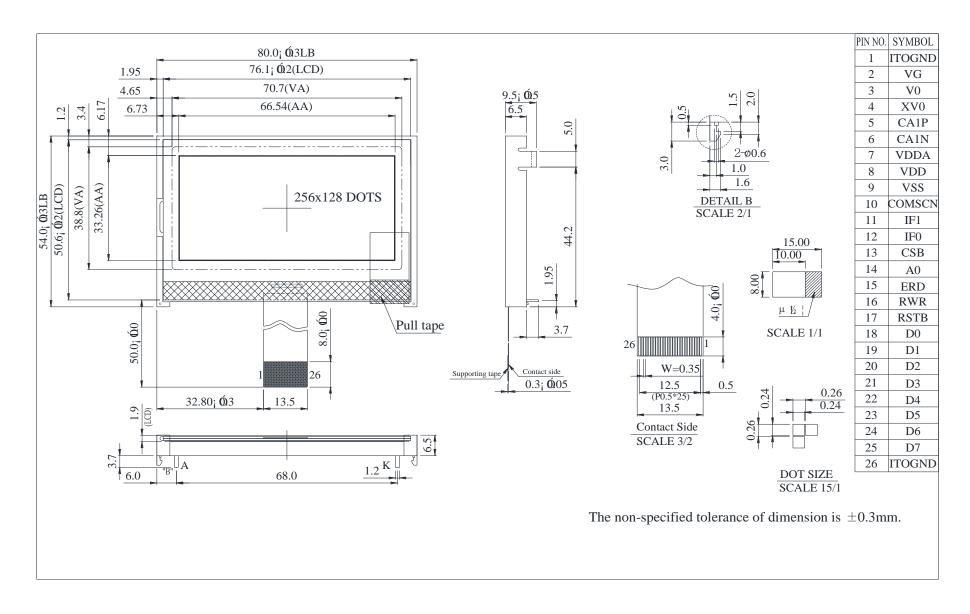
Definition of viewing angle $(CR \ge 2)$



7.Interface Pin Function

Pin No.	Symbol	Description						
1	ITOGND	ESD PIN	ESD PIN					
2	VG	Power of	SEG-d	rivers				
3	V0	Positive	operatin	g voltage of COM-drivers				
4	XV0	Negative	operati	ng voltage of COM-drivers				
5	CA1P	DC/DC	Voltage	converte pin				
6	CA1N	DC/DC	Voltage	converte pin				
7	VDDA	+3.3V						
8	VDD	+3.3V						
9	VSS	ground						
10	COMSCN	Set scan	Set scan directing of COM					
11	IF1	These pi	These pins select interface operation mode.					
		IF1	IF0	MPU interface type				
		L	L	4-line serial interface				
12	IF0	L	Н	IIC serial interface				
12	IFU	Н	L	8-bit 6800 parallel interface				
		Н	Н	8-bit 8080 parallel interface				
		Note: Ref	er to "Par	allel / Serial Interface" for detailed information.				
13	CSB	Chip sele	ect input	t pin				
14	A0	Whether	the acce	ess is related to data or command				
15	ERD	Read or	write en	able terminal				
16	RWR	Read/Wr	ite exec	ution control pin				
17	RSTB	Reset inp	Reset input pin					
18~25	D0~D7	Data bus	line					
26	ITOGND	ESD PIN	1					

8.Contour Drawing



9.Reliability

Content of Reliability Test (Wide temperature, -20 $^{\circ}$ C)

	Environmental Test						
Test Item	Content of Test	Test Condition	Not e				
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2				
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	_				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1				
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2				
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation $-20^{\circ}\text{C} \qquad 25^{\circ}\text{C} \qquad 70^{\circ}\text{C}$ 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	_				
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3				
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times	_				

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

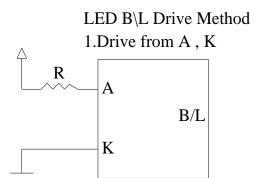
10.Backlight Information

Specification

	1	1	_	_		
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	_	96	120	mA	V=3.5V
Supply Voltage	V	3.3	3.5	3.7	V	_
Reverse Voltage	VR	_		5	V	_
Luminance	IV	840	1050		CD/M ²	ILED=96mA
(Without LCD)	l v	040	1030		CD/M	ILED=90IIIA
LED Life Time						ILED=96mA
(For Reference	_	_	50K	_	Hr.	25℃,50-60%RH,
only)						(Note 1)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.



11.Inspection specification

NO	Item	Criterion				AQL	
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect. Missing character, dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.					
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 				2.5	
LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi=(x+y)/2$ X 3.2 Line type:	<u>↓</u>	$Φ \le 0.10$ $0.10 < Φ \le 0.20$ $0.20 < Φ \le 0.25$ $0.25 < Φ$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY	2.5		
	(non-display) → L w	 L≦3.0 L≦2.5	$\begin{array}{c} \text{W} \leq 0.02 \\ 0.02 < \text{W} \leq 0.03 \\ 0.03 < \text{W} \leq 0.05 \\ 0.05 < \text{W} \end{array}$	Accept no dense 2 As round type	2.5		
04	Polarizer bubbles	If bubbles are v judge using bla specifications, to to find, must ch specify direction	ck spot not easy neck in	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5	

NO	Item	Criterion						
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination						
			Glass thickness a: LC	nip thickness CD side length				
		6.1 General glass chip : 6.1.1 Chip on panel sur	face and crack between	panels:				
		z: Chip thickness	y: Chip width	x: Chip length				
0.5	Chipped	Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5			
06	glass	$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a	2.5			
		o If there are 2 or more 6.1.2 Corner crack: $ z$: Chip thickness $ z \le 1/2t $ $ 1/2t < z \le 2t$	y: Chip width Not over viewing area Not exceed 1/3k	of each chip. $ x \colon \text{Chip length} $ $ x \leqq 1/8a $ $ x \leqq 1/8a $				
		⊙ If there are 2 or more	e chips, x is the total len	gth of each chip.				

NO	Item	Criterion			AQL			
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:						
				z: Chip thickness $0 < z \le t$				
06	Glass	y 12 x 12						
		y: Chip width	x: Chip length	z: Chip thickness				
		$y \le L$	x ≤ 1/8a	$0 < z \le t$				
		 ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. ⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged. 6.2.3 Substrate protuberance and internal crack. y: width y: length $y \le 1/3L$ $x \le a$ 						

NO	Item Criterion		AQL	
07	Cracked glass The LCD with extensive crack is not acceptable.		2.5	
08 Backlight elements		 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 		
09	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.			
	PCB、COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height	2.5 2.5 0.65	
		indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.	2.5	
10		10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	2.5 0.65	
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65	
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5	
		10.9 The Scraping testing standard for Copper Coating of PCB X X * Y <= 2mm ²	2.5	
	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5	
11		11.2 No cold solder joints, missing solder connections, oxidation or icicle.	2.5	
11		11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 0.65	

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value ppm ppm ppm ppm ppm ppm ppm ppm ppm pp										
Above limited value is set up according to RoHS.										

- 2.Process for RoHS requirement : (only for RoHS inspection)
 - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
 - (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

			Feedback Sheet	
	Number:			Page: 1
1 \ <u>P</u>	anel Specification:		_	
1.	Panel Type:	Pass	☐ NG ,	
2.	View Direction:	Pass	☐ NG ,	
3.	Numbers of Dots:	Pass	☐ NG ,	
4.	View Area:	Pass	☐ NG ,	
5.	Active Area:	Pass	☐ NG ,	
6.	Operating Temperature:	Pass	☐ NG ,	
7.	Storage Temperature:	Pass	☐ NG ,	
8.	Others:			
2 · <u>N</u>	Iechanical Specification :			
1.	PCB Size:	Pass	☐ NG ,	
2.	Frame Size:	☐ Pass	☐ NG ,	
3.	Materal of Frame:	☐ Pass	☐ NG ,	
4.	Connector Position:	Pass	☐ NG ,	
5.	Fix Hole Position:	Pass	☐ NG ,	
6.	Backlight Position:	Pass	☐ NG ,	
7.	Thickness of PCB:	Pass	☐ NG ,	
8.	Height of Frame to PCB:	Pass	☐ NG ,	
9.	Height of Module:	Pass	☐ NG ,	
10.	Others:	☐ Pass	☐ NG ,	
3 \ <u>R</u>	telative Hole Size :			
1.	Pitch of Connector:	☐ Pass	☐ NG ,	
2.	Hole size of Connector:	☐ Pass		
3.	Mounting Hole size:	Pass	☐ NG ,	
4.	Mounting Hole Type:	Pass		
5.	Others:	☐ Pass		
4、 <u>B</u>	acklight Specification :			
1.	B/L Type:	☐ Pass	☐ NG ,	
2.	B/L Color:	☐ Pass		
3.	B/L Driving Voltage (Refere	nce for LED		
	B/L Driving Current:	☐ Pass		
5.	Brightness of B/L:	☐ Pass		
	B/L Solder Method:	☐ Pass		
7	Others:	Pass		



	Anstar Number :		Page: 2			
	ectronic Characteristics of		- 1.6-1.			
	nput Voltage:	☐ Pass	□ NG ,			
	upply Current:	☐ Pass	□ NG ,			
	Oriving Voltage for LCD:	☐ Pass	□ NG ,			
4. C	Contrast for LCD:	Pass	□ NG ,			
5. B	/L Driving Method:	☐ Pass	□ NG ,			
6. N	legative Voltage Output:	☐ Pass	□ NG ,			
7. Ir	nterface Function:	☐ Pass	□ NG ,			
8. L	CD Uniformity:	☐ Pass	□ NG ,			
9. E	SD test:	☐ Pass	☐ NG ,			
10. O	Others:	☐ Pass	□ NG ,			
6 · <u>St</u>	ımmary :					
	Sales signature: Customer Signature:		Date: / /			

14.External Power Supply Circuit

